

# Automotive N-Channel 20 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY									
V <sub>DS</sub> (V)	20								
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.028								
$R_{DS(on)}(\Omega)$ at $V_{GS} = 2.5 \text{ V}$	0.034								
$R_{DS(on)}(\Omega)$ at $V_{GS} = 1.8 \text{ V}$	0.038								
I <sub>D</sub> (A)	7.8								
Configuration	Single								

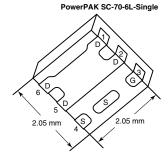
#### **FEATURES**

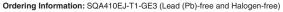
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- AEC-Q101 Qualified d
- 100 % R<sub>q</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

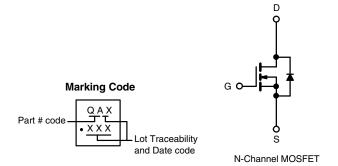


ROHS









ORDERING INFORMATION						
Package	PowerPAK SC-70					
Lead (Pb)-free and Halogen-free	SQA410EJ-T1-GE3					

ABSOLUTE MAXIMUM RATINGS	(T <sub>C</sub> = 25 °C, unless	s otherwise noted	i)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		$V_{DS}$	20			
Gate-Source Voltage		V <sub>GS</sub>	± 8	V		
Continuous Drain Currenta	T <sub>C</sub> = 25 °C	I-	7.8			
Continuous Diain Currents	T <sub>C</sub> = 125 °C	I <sub>D</sub>	7.8			
Continuous Source Current (Diode Conduction	) <sup>a</sup>	Is	7.8	А		
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	24			
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	10			
Single Pulse Avalanche Energy	L = 0.1 IIIH	E <sub>AS</sub>	5	mJ		
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	13.6	W		
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 125 °C	r <sub>D</sub>	4.5	VV		
Operating Junction and Storage Temperature F	Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperatu		260	°C			

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	LIMIT	UNIT					
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	90	°C/W					
Junction-to-Case (Drain)		$R_{thJC}$	11	C/VV					

## Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.
- e. See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				,		l .		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	20		-	V		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	0.45	0.6	1.1	v	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	= 0 V, V <sub>GS</sub> = ± 8 V	-	-	± 100	nA	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 20 V	-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 20 V, T <sub>J</sub> = 125 °C	-	-	50	μΑ	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 20 V, T <sub>J</sub> = 175 °C	-	-	250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 4.5 V	$V_{DS} \ge 5 V$	10	-	-	Α	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 5 A	-	0.023	0.028		
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 5 A, T <sub>J</sub> = 125 °C	-	-	0.042		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 5 A, T <sub>J</sub> = 175 °C	-	-	0.050	Ω	
		V <sub>GS</sub> = 2.5 V	I <sub>D</sub> = 4 A	-	0.026	0.034		
		V <sub>GS</sub> = 1.8 V	I <sub>D</sub> = 3 A	-	0.031	0.038	1	
Forward Transconductanceb	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 5 A	-	31	-	S	
Dynamic <sup>b</sup>								
out Capacitance C <sub>iss</sub>				-	388	485		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 10 V, f = 1 MHz	-	80	100	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	36	45		
Total Gate Charge <sup>c</sup>	Qg			-	5	8		
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	$V_{GS} = 4.5 \text{ V}$	$V_{DS} = 10 \text{ V}, I_{D} = 5.1 \text{ A}$	-	0.55	-	nC	
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$		1		0.79	-	1	
Gate Resistance	R <sub>g</sub>	f = 1 MHz		6	11.89	18	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	8	12		
Rise Time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> :	-	8	12	ns		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	I <sub>D</sub> ≅ 1 Å, \	-	21	32			
Fall Time <sup>c</sup>	t <sub>f</sub>			-	8	12		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>							
Pulsed Current <sup>a</sup>	I <sub>SM</sub>		-	-	24	Α		
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> =	4.5 A, V <sub>GS</sub> = 0 V	-	0.75	1.2	V	

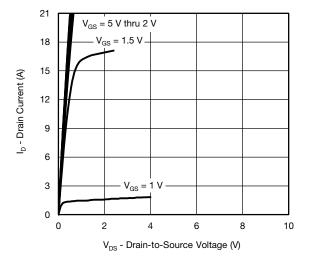
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

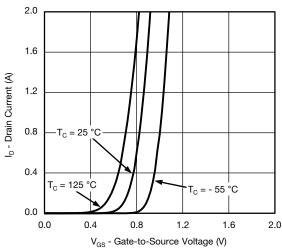
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



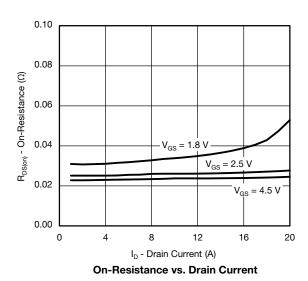
# **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

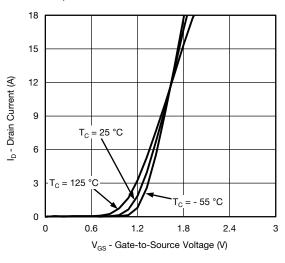


### **Output Characteristics**

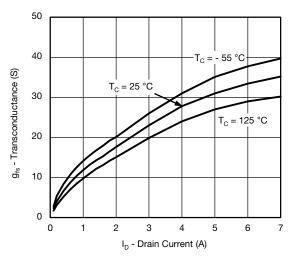


## Transfer Characteristics

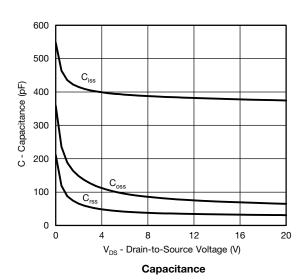




#### **Transfer Characteristics**

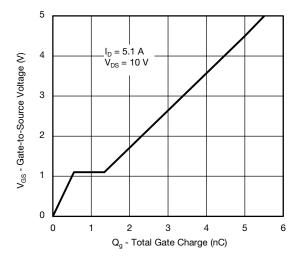


#### Transconductance

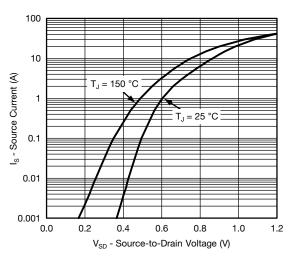




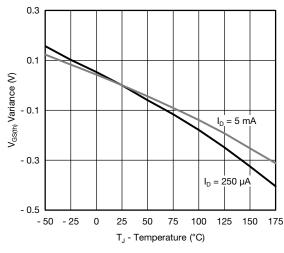
# **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



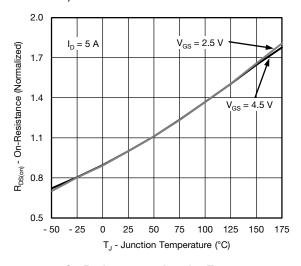
#### **Gate Charge**



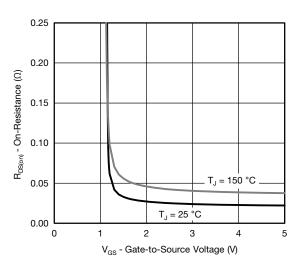
## **Source Drain Diode Forward Voltage**



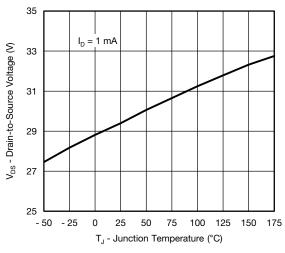
**Threshold Voltage** 



#### On-Resistance vs. Junction Temperature



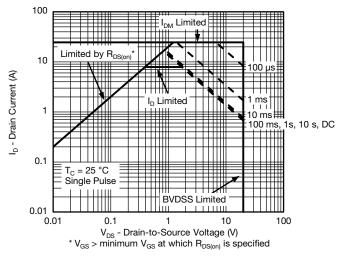
## On-Resistance vs. Gate-to-Source Voltage



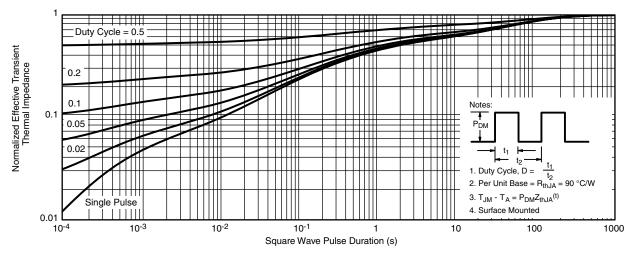
**Drain Source Breakdown vs. Junction Temperature** 



# **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)

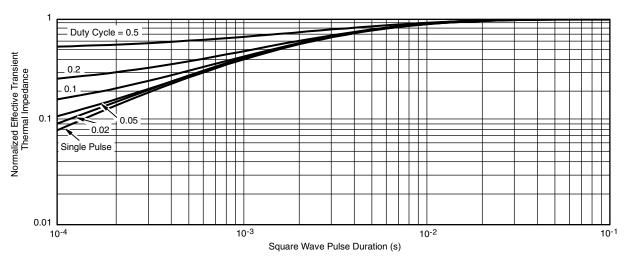


Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

# THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

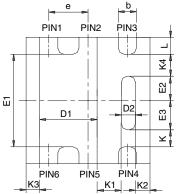
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

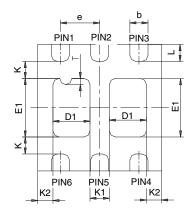
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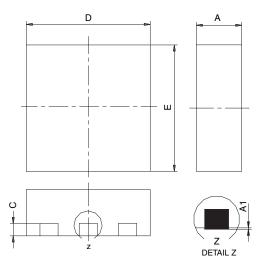
# PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
  Package outline exclusive of mold flash and metal burr
  Package outline inclusive of plating

	SINGLE PAD						DUAL PAD					
DIM	M	ILLIMETER	RS		INCHES		М	ILLIMETER	RS		INCHES	
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
<b>A</b> 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;		0.65 BSC			0.026 BSC	
K		0.275 TYP			0.011 TYP		0.275 TYP			0.011 TYP		
K1		0.400 TYP			0.016 TYP		0.320 TYP			0.013 TYP		
K2		0.240 TYP		0.009 TYP		0.252 TYP			0.010 TYP			
К3		0.225 TYP		0.009 TYP								
K4		0.355 TYP		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006
ECN: C O	7/21 Do	, C 06 Aug	1 07									

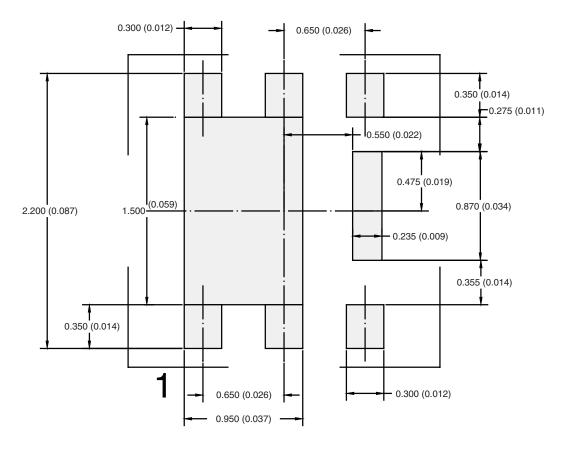
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

Document Number: 73001 06-Aug-07



# RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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ATTLICA ION NOI



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